

Final datasheet

The Soft 650 V Emitter Controlled Si Diode 7 offers improved reliability for both Industrial and Home Appliance applications

Features

- $V_{RRM} = 650\text{ V}$
- $I_F = 150\text{ A}$
- Low and temperature stable forward voltage ( $V_F$ )
- Very soft and fast recovery
- Low reverse recovery current ( $I_{rrm}$ )
- Humidity robust design
- Cosmic ray ruggedness
- Maximum junction temperature  $T_{vjmax} = 175^{\circ}\text{C}$
- Qualified according to JEDEC for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models: <http://www.infineon.com/ec7/>

Potential applications

- String and micro inverter
- Datacenter UPS
- Offline UPS/Residential UPS
- Online UPS/Industrial UPS
- Residential aircon
- Welding

Product validation

- Qualified for industrial applications according to the relevant tests of JEDEC47/20/22

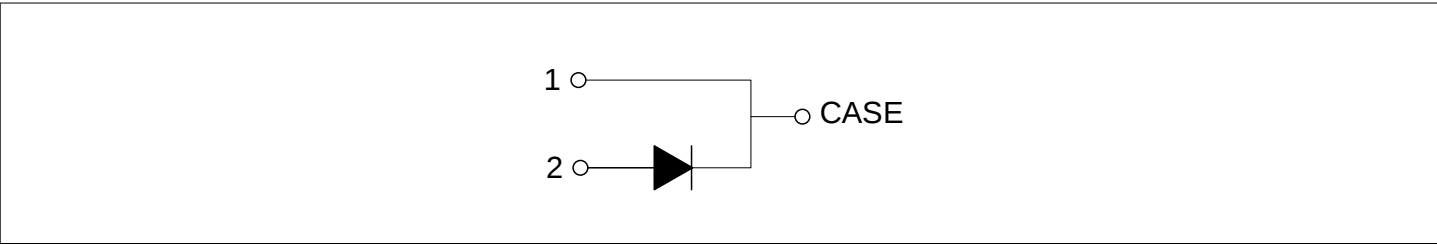
Description

Pin definition:

- Pin 1 and backside - Cathode
- Pin 2 - Anode



- Green
- Halogen-free
- Lead-free
- RoHS



| Type         | Package              | Marking |
|--------------|----------------------|---------|
| IDWD150E65E7 | PG-TO247-2-STD-NA8.8 | E150EE7 |



Table of contents

|   |                                |    |
|---|--------------------------------|----|
|   | Description .....              | 1  |
|   | Features .....                 | 1  |
|   | Potential applications .....   | 1  |
|   | Product validation .....       | 1  |
|   | Table of contents .....        | 2  |
| 1 | Package .....                  | 3  |
| 2 | Diode .....                    | 3  |
| 3 | Characteristics diagrams ..... | 6  |
| 4 | Package outlines .....         | 8  |
| 5 | Testing conditions .....       | 9  |
|   | Revision history .....         | 10 |
|   | Disclaimer .....               | 11 |

## 1 Package

## 1 Package

Table 1 Characteristic values

| Parameter                                                       | Symbol        | Note or test condition                               | Values |      |      | Unit |
|-----------------------------------------------------------------|---------------|------------------------------------------------------|--------|------|------|------|
|                                                                 |               |                                                      | Min.   | Typ. | Max. |      |
| Internal emitter inductance measured 5 mm (0.197 in.) from case | $L_E$         |                                                      |        | 13   |      | nH   |
| Storage temperature                                             | $T_{stg}$     |                                                      | -55    |      | 150  | °C   |
| Soldering temperature                                           | $T_{sold}$    | wave soldering 1.6 mm (0.063 in.) from case for 10 s |        |      | 260  | °C   |
| Mounting torque                                                 | $M$           | M3 screw, Maximum of mounting processes: 3           |        |      | 0.6  | Nm   |
| Thermal resistance, junction-ambient                            | $R_{th(j-a)}$ |                                                      |        |      | 40   | K/W  |
| Diode thermal resistance, junction-case                         | $R_{th(j-c)}$ |                                                      |        |      | 0.33 | K/W  |

## 2 Diode

Table 2 Maximum rated values

| Parameter                                                 | Symbol       | Note or test condition     |                       | Values | Unit |
|-----------------------------------------------------------|--------------|----------------------------|-----------------------|--------|------|
| Repetitive peak reverse voltage                           | $V_{RRM}$    | $T_{vj} \geq 25\text{ °C}$ |                       | 650    | V    |
| Diode forward current, limited by $T_{vjmax}$             | $I_F$        | limited by bondwire        | $T_c = 25\text{ °C}$  | 200    | A    |
|                                                           |              |                            | $T_c = 100\text{ °C}$ | 153    |      |
| Diode pulsed current, $t_p$ limited by $T_{vjmax}$        | $I_{Fpulse}$ |                            |                       | 600    | A    |
| Diode surge non repetitive forward current, sine halfwave | $I_{FSM}$    | $t_p = 10\text{ ms}$       | $T_c = 25\text{ °C}$  | 600    | A    |
| Power dissipation                                         | $P_{tot}$    |                            | $T_c = 25\text{ °C}$  | 453    | W    |
|                                                           |              |                            | $T_c = 100\text{ °C}$ | 227    |      |

Table 3 Characteristic values

| Parameter             | Symbol | Note or test condition |                          | Values |      |      | Unit |
|-----------------------|--------|------------------------|--------------------------|--------|------|------|------|
|                       |        |                        |                          | Min.   | Typ. | Max. |      |
| Diode forward voltage | $V_F$  | $I_F = 150\text{ A}$   | $T_{vj} = 25\text{ °C}$  |        | 1.65 | 2.1  | V    |
|                       |        |                        | $T_{vj} = 125\text{ °C}$ |        | 1.6  |      |      |
|                       |        |                        | $T_{vj} = 175\text{ °C}$ |        | 1.55 |      |      |

(table continues...)

Table 3 (continued) Characteristic values

| Parameter                           | Symbol    | Note or test condition |                                                                                                                 | Values |      |      | Unit          |
|-------------------------------------|-----------|------------------------|-----------------------------------------------------------------------------------------------------------------|--------|------|------|---------------|
|                                     |           |                        |                                                                                                                 | Min.   | Typ. | Max. |               |
| Reverse leakage current             | $I_R$     | $V_R = 650 \text{ V}$  | $T_{vj} = 25 \text{ }^{\circ}\text{C}$                                                                          |        |      | 20   | $\mu\text{A}$ |
|                                     |           |                        | $T_{vj} = 175 \text{ }^{\circ}\text{C}$                                                                         |        | 1160 |      |               |
| Diode reverse recovery time         | $t_{rr}$  | $V_R = 400 \text{ V}$  | $T_{vj} = 25 \text{ }^{\circ}\text{C}$ ,<br>$I_F = 150 \text{ A}$ ,<br>$-di_F/dt = 1000 \text{ A}/\mu\text{s}$  |        | 97   |      | ns            |
|                                     |           |                        | $T_{vj} = 25 \text{ }^{\circ}\text{C}$ ,<br>$I_F = 75 \text{ A}$ ,<br>$-di_F/dt = 1000 \text{ A}/\mu\text{s}$   |        | 88.3 |      |               |
|                                     |           |                        | $T_{vj} = 175 \text{ }^{\circ}\text{C}$ ,<br>$I_F = 150 \text{ A}$ ,<br>$-di_F/dt = 1000 \text{ A}/\mu\text{s}$ |        | 175  |      |               |
|                                     |           |                        | $T_{vj} = 175 \text{ }^{\circ}\text{C}$ ,<br>$I_F = 75 \text{ A}$ ,<br>$-di_F/dt = 1000 \text{ A}/\mu\text{s}$  |        | 148  |      |               |
| Diode reverse recovery charge       | $Q_{rr}$  | $V_R = 400 \text{ V}$  | $T_{vj} = 25 \text{ }^{\circ}\text{C}$ ,<br>$I_F = 150 \text{ A}$ ,<br>$-di_F/dt = 1000 \text{ A}/\mu\text{s}$  |        | 2.16 |      | $\mu\text{C}$ |
|                                     |           |                        | $T_{vj} = 25 \text{ }^{\circ}\text{C}$ ,<br>$I_F = 75 \text{ A}$ ,<br>$-di_F/dt = 1000 \text{ A}/\mu\text{s}$   |        | 1.75 |      |               |
|                                     |           |                        | $T_{vj} = 175 \text{ }^{\circ}\text{C}$ ,<br>$I_F = 150 \text{ A}$ ,<br>$-di_F/dt = 1000 \text{ A}/\mu\text{s}$ |        | 6.4  |      |               |
|                                     |           |                        | $T_{vj} = 175 \text{ }^{\circ}\text{C}$ ,<br>$I_F = 75 \text{ A}$ ,<br>$-di_F/dt = 1000 \text{ A}/\mu\text{s}$  |        | 5.2  |      |               |
| Diode peak reverse recovery current | $I_{rrm}$ | $V_R = 400 \text{ V}$  | $T_{vj} = 25 \text{ }^{\circ}\text{C}$ ,<br>$I_F = 150 \text{ A}$ ,<br>$-di_F/dt = 1000 \text{ A}/\mu\text{s}$  |        | 33.4 |      | A             |
|                                     |           |                        | $T_{vj} = 25 \text{ }^{\circ}\text{C}$ ,<br>$I_F = 75 \text{ A}$ ,<br>$-di_F/dt = 1000 \text{ A}/\mu\text{s}$   |        | 27.8 |      |               |
|                                     |           |                        | $T_{vj} = 175 \text{ }^{\circ}\text{C}$ ,<br>$I_F = 150 \text{ A}$ ,<br>$-di_F/dt = 1000 \text{ A}/\mu\text{s}$ |        | 56.3 |      |               |
|                                     |           |                        | $T_{vj} = 175 \text{ }^{\circ}\text{C}$ ,<br>$I_F = 75 \text{ A}$ ,<br>$-di_F/dt = 1000 \text{ A}/\mu\text{s}$  |        | 52   |      |               |

(table continues...)

Table 3 (continued) Characteristic values

| Parameter                                           | Symbol       | Note or test condition |                                                                                                               | Values |      |      | Unit                   |
|-----------------------------------------------------|--------------|------------------------|---------------------------------------------------------------------------------------------------------------|--------|------|------|------------------------|
|                                                     |              |                        |                                                                                                               | Min.   | Typ. | Max. |                        |
| Diode peak rate of fall of reverse recovery current | $di_{rr}/dt$ | $V_R = 400 \text{ V}$  | $T_{vj} = 25 \text{ }^\circ\text{C}$ ,<br>$I_F = 150 \text{ A}$ ,<br>$-di_F/dt = 1000 \text{ A}/\mu\text{s}$  |        | 1500 |      | $\text{A}/\mu\text{s}$ |
|                                                     |              |                        | $T_{vj} = 25 \text{ }^\circ\text{C}$ ,<br>$I_F = 75 \text{ A}$ ,<br>$-di_F/dt = 1000 \text{ A}/\mu\text{s}$   |        | 1500 |      |                        |
|                                                     |              |                        | $T_{vj} = 175 \text{ }^\circ\text{C}$ ,<br>$I_F = 150 \text{ A}$ ,<br>$-di_F/dt = 1000 \text{ A}/\mu\text{s}$ |        | 1160 |      |                        |
|                                                     |              |                        | $T_{vj} = 175 \text{ }^\circ\text{C}$ ,<br>$I_F = 75 \text{ A}$ ,<br>$-di_F/dt = 1000 \text{ A}/\mu\text{s}$  |        | 1720 |      |                        |
| Reverse recovery energy                             | $E_{rec}$    | $V_R = 400 \text{ V}$  | $T_{vj} = 25 \text{ }^\circ\text{C}$ ,<br>$I_F = 150 \text{ A}$ ,<br>$-di_F/dt = 1000 \text{ A}/\mu\text{s}$  |        | 0.29 |      | $\text{mJ}$            |
|                                                     |              |                        | $T_{vj} = 25 \text{ }^\circ\text{C}$ ,<br>$I_F = 75 \text{ A}$ ,<br>$-di_F/dt = 1000 \text{ A}/\mu\text{s}$   |        | 0.23 |      |                        |
|                                                     |              |                        | $T_{vj} = 175 \text{ }^\circ\text{C}$ ,<br>$I_F = 150 \text{ A}$ ,<br>$-di_F/dt = 1000 \text{ A}/\mu\text{s}$ |        | 0.99 |      |                        |
|                                                     |              |                        | $T_{vj} = 175 \text{ }^\circ\text{C}$ ,<br>$I_F = 75 \text{ A}$ ,<br>$-di_F/dt = 1000 \text{ A}/\mu\text{s}$  |        | 0.81 |      |                        |
| Operating junction temperature                      | $T_{vj}$     |                        |                                                                                                               | -40    |      | 175  | $^\circ\text{C}$       |

Note: For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

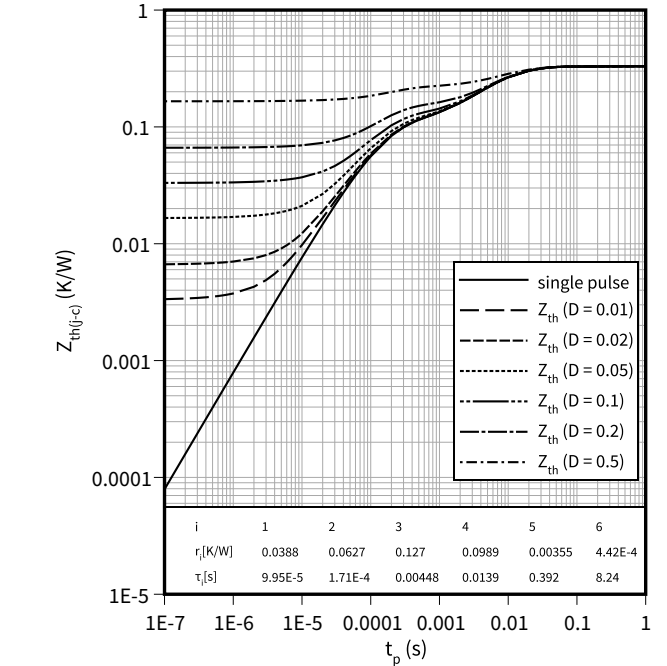
Electrical Characteristic at  $T_{vj} = 25^\circ\text{C}$ , unless otherwise specified.

Dynamic test circuit, parasitic inductance  $L_\sigma = 30 \text{ nH}$ , parasitic capacitor  $C_\sigma = 18 \text{ pF}$  from Fig. E.

3 Characteristics diagrams

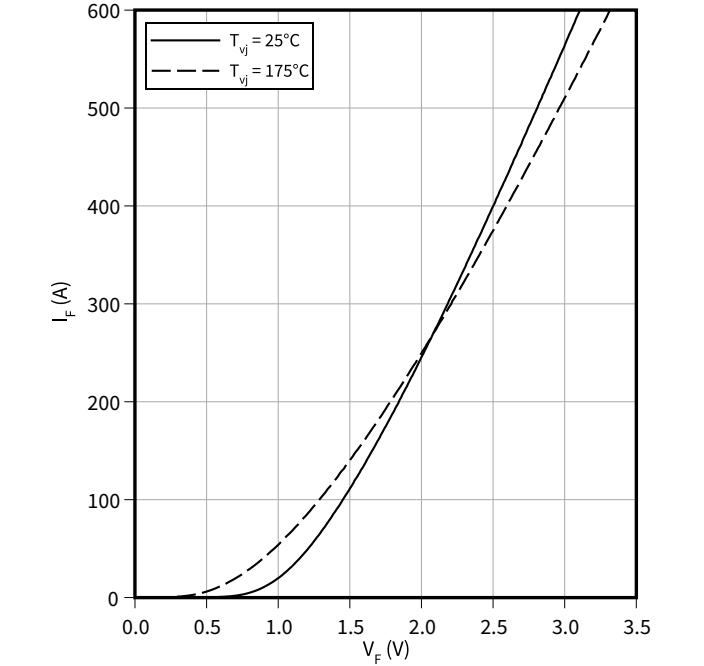
Diode transient thermal impedance as a function of pulse width

$Z_{th(j-c)} = f(t_p)$   
 $D = t_p/T$



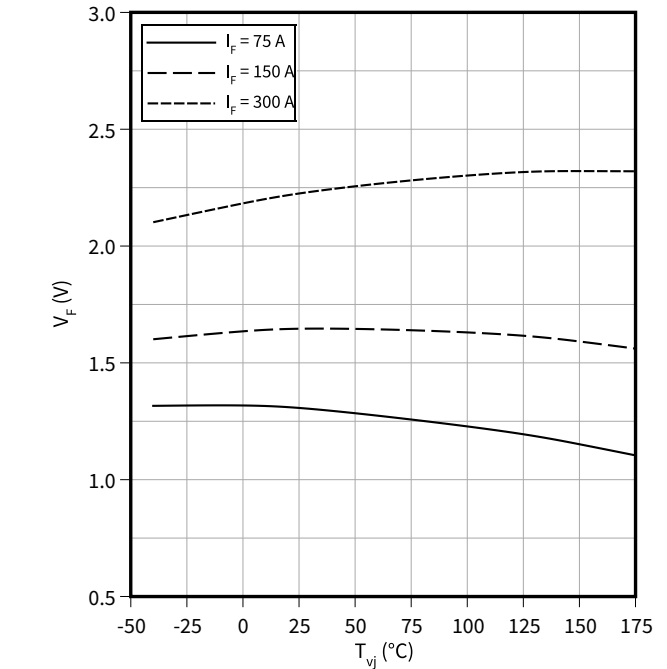
Typical diode forward current as a function of forward voltage

$I_F = f(V_F)$



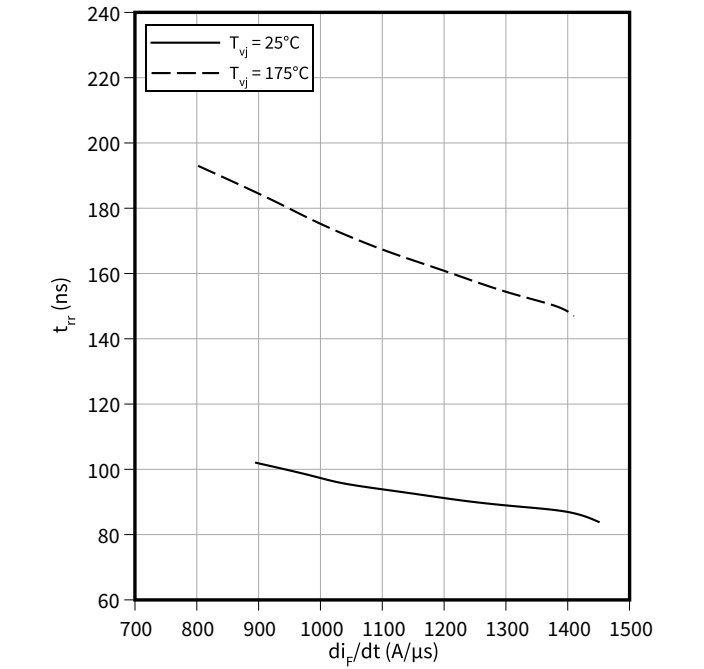
Typical diode forward voltage as a function of junction temperature

$V_F = f(T_{vj})$



Typical reverse recovery time as a function of diode current slope

$t_{rr} = f(di_F/dt)$   
 $V_R = 400\text{ V}, I_F = 150\text{ A}$

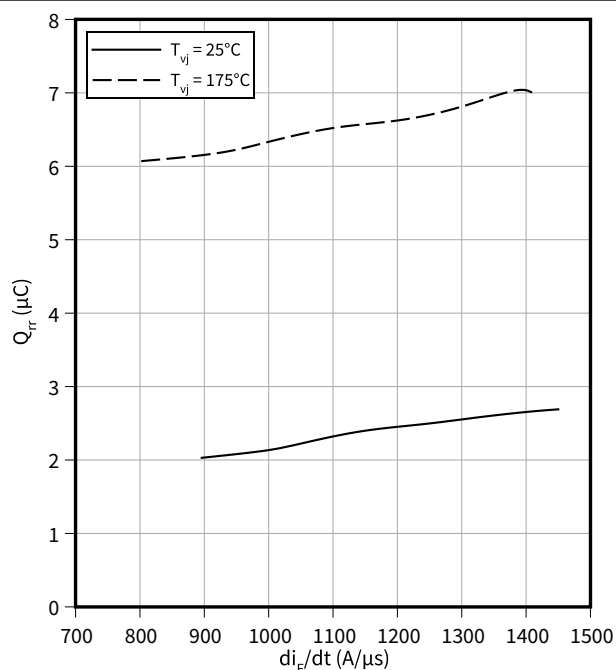


## 3 Characteristics diagrams

**Typical reverse recovery charge as a function of diode current slope**

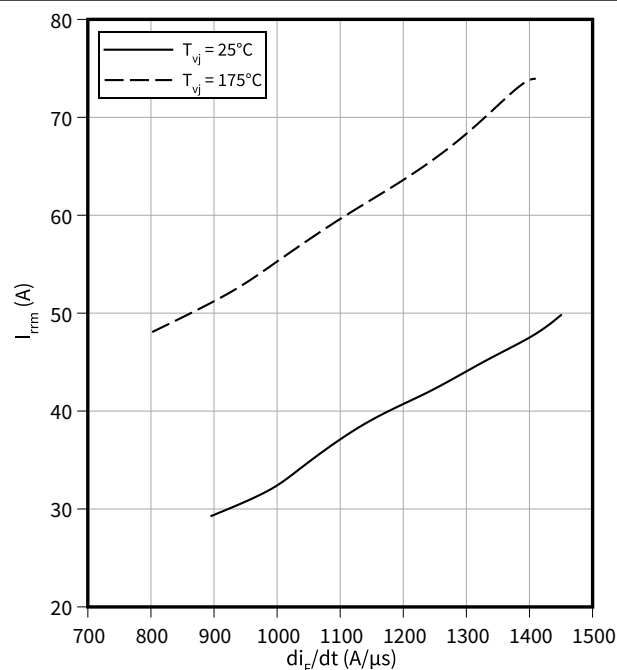
$$Q_{rr} = f(di_F/dt)$$

$$V_R = 400 \text{ V}, I_F = 150 \text{ A}$$

**Typical reverse recovery current as a function of diode current slope**

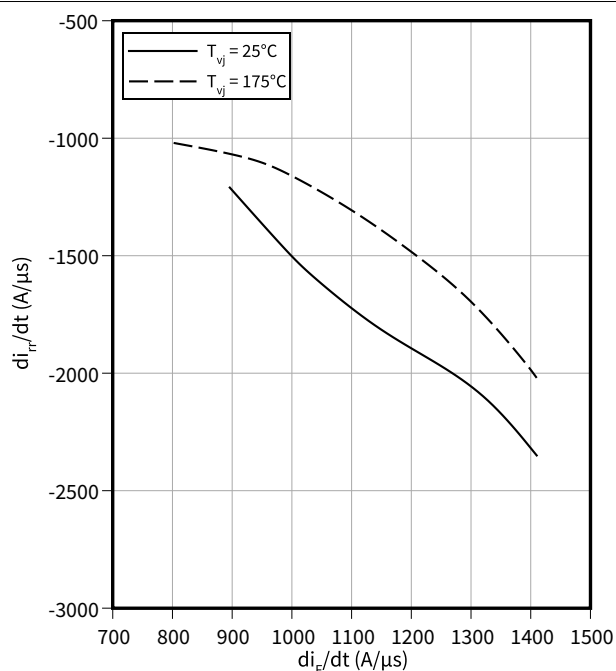
$$I_{rrm} = f(di_F/dt)$$

$$V_R = 400 \text{ V}, I_F = 150 \text{ A}$$

**Typical diode peak rate of fall of reverse recovery current as a function of diode current slope**

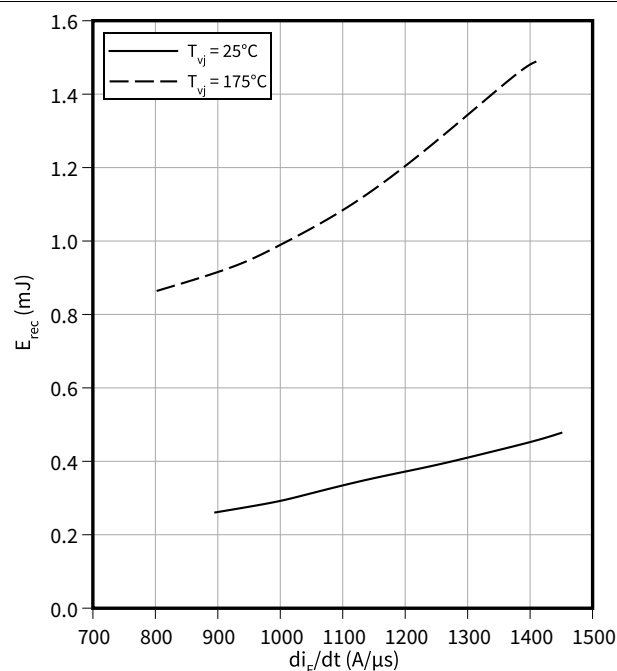
$$di_{rr}/dt = f(di_F/dt)$$

$$V_R = 400 \text{ V}, I_F = 150 \text{ A}$$

**Typical reverse energy losses as a function of diode current slope**

$$E_{rec} = f(di_F/dt)$$

$$V_R = 400 \text{ V}, I_F = 150 \text{ A}$$



4 Package outlines

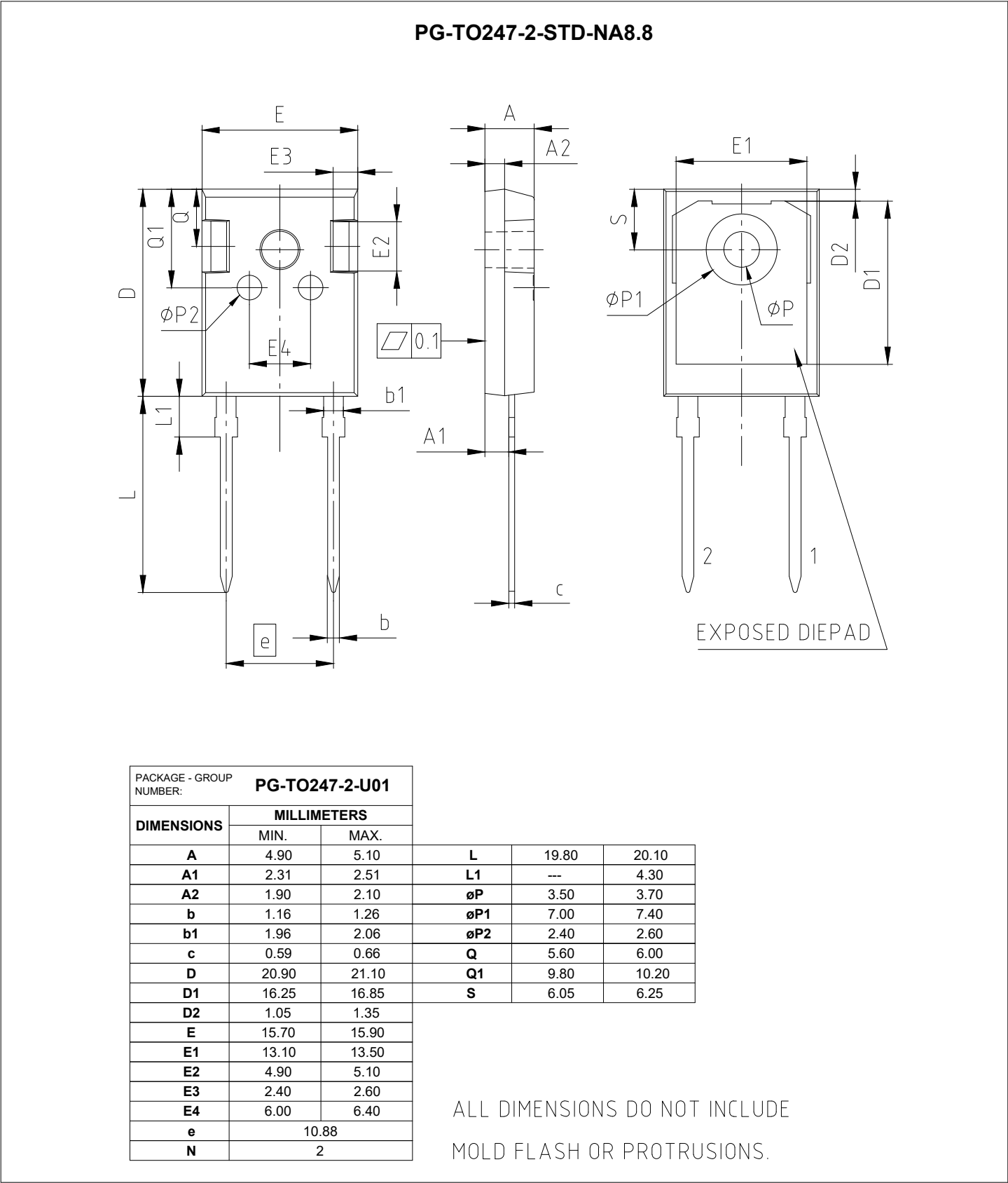


Figure 1

## 5 Testing conditions

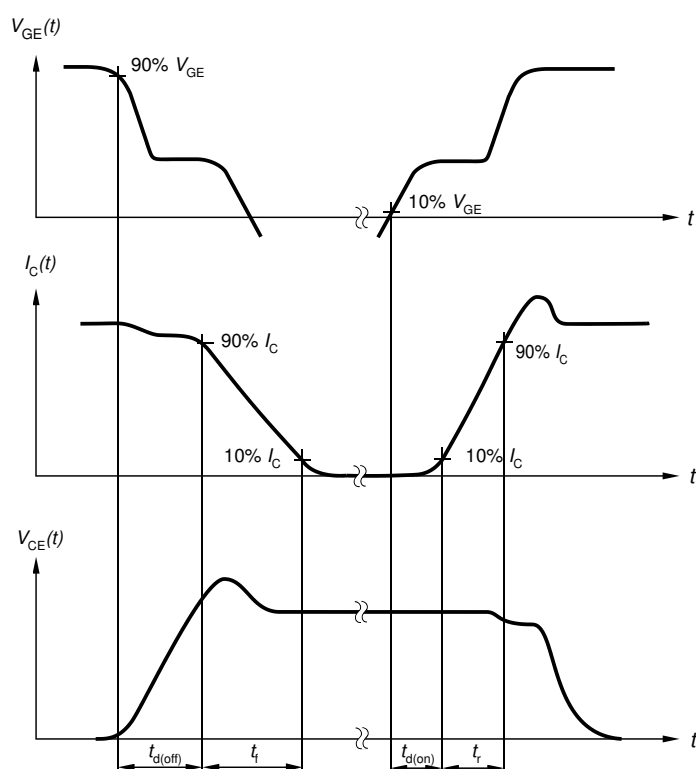


Figure A. Definition of switching times

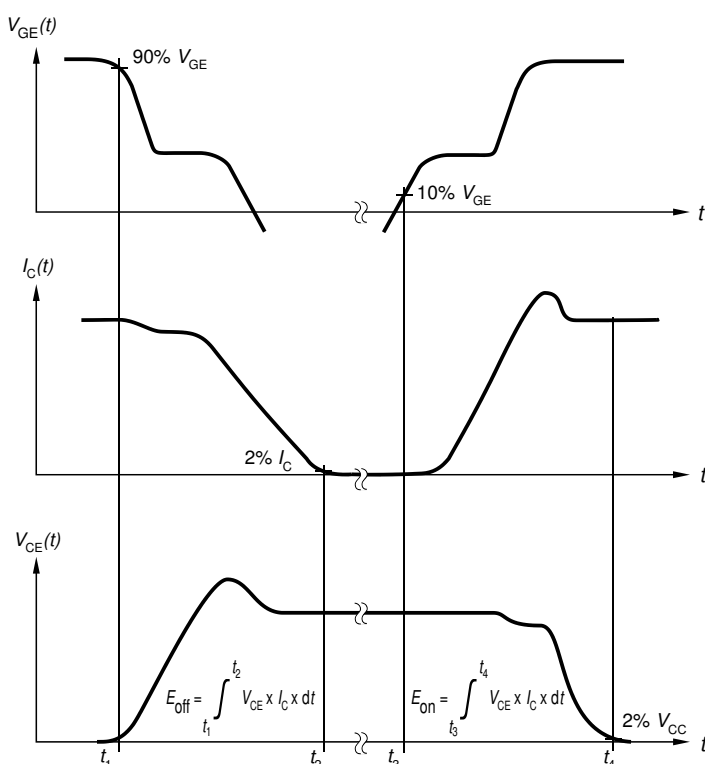


Figure B. Definition of switching losses

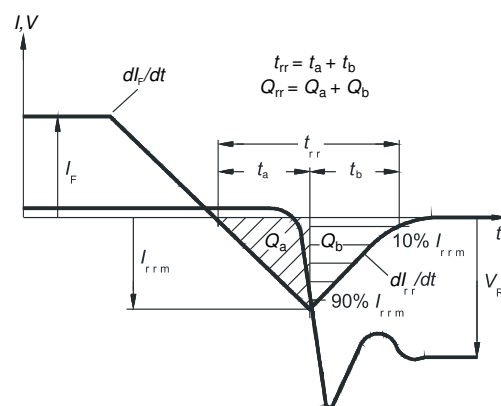


Figure C. Definition of diode switching characteristics

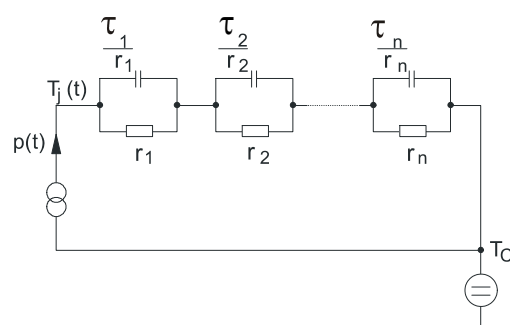


Figure D. Thermal equivalent circuit

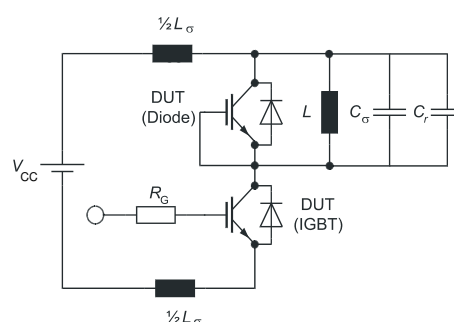


Figure E. **Dynamic test circuit**  
Parasitic inductance  $L_\sigma$ ,  
parasitic capacitor  $C_\sigma$ ,  
relief capacitor  $C_r$ ,  
(only for ZVT switching)

**Revision history**

| Document revision | Date of release | Description of changes                                             |
|-------------------|-----------------|--------------------------------------------------------------------|
| 0.10              | 2023-04-26      | Preliminary datasheet                                              |
| 1.00              | 2023-05-02      | Final datasheet                                                    |
| 1.10              | 2023-11-06      | Update of diode forward current $I_F$<br>Update of graph on page 6 |

## Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

**Edition 2023-11-06**

**Published by**

**Infineon Technologies AG**  
**81726 Munich, Germany**

**© 2023 Infineon Technologies AG**  
**All Rights Reserved.**

**Do you have a question about any aspect of this document?**

**Email:** [erratum@infineon.com](mailto:erratum@infineon.com)

**Document reference**  
**IFX-ABG821-003**

## Important notice

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenhheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

Please note that this product is not qualified according to the AEC Q100 or AEC Q101 documents of the Automotive Electronics Council.

## Warnings

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.